

APT50GR120B2 APT50GR120L

1200V, 50A, $\rm V_{ce(on)}\,$ = 2.5V Typical

Ultra Fast NPT - IGBT®

The Ultra Fast NPT - IGBT[®] family of products is the newest generation of planar IGBTs optimized for outstanding ruggedness and the best trade-off between conduction and switching losses.

Features

- Low Saturation Voltage
- Low Tail Current
- RoHS Compliant *M*

- Short Circuit Withstand Rated
- High Frequency Switching
- Ultra Low Leakage Current

Unless stated otherwise, Microsemi discrete IGBTs contain a single IGBT die. This device is recommended for applications such as induction heating (IH), motor control, general purpose inverters and uninterruptible power supplies (UPS).

MAXIMUM RATINGS

All Ratings: $T_c = 25^{\circ}C$ unless otherwise specified.

Symbol	Parameter	Ratings	Unit	
V _{ces}	Collector Emitter Voltage	1200	- v	
V _{GE}	Gate-Emitter Voltage	±30		
I _{C1}	Continuous Collector Current @ $T_c = 25^{\circ}C$	117		
I _{C2}	Continuous Collector Current @ T _c = 110°C	50	А	
I _{CM}	Pulsed Collector Current ①	200		
SCWT	Short Circuit Withstand Time: V_{CE} = 600V, V_{GE} = 15V, T_{C} = 125°C	10	μs	
P _D	Total Power Dissipation @ T_c = 25°C	694	W	
T_,T _{stg}	Operating and Storage Junction Temperature Range	-55 to 150		
TL	Max. Lead Temp. for Soldering: 0.063" from Case for 10 Sec.	300	°C	

STATIC ELECTRICAL CHARACTERISTICS

Symbol	Parameter	Min	Тур	Max	Unit
V _{(BR)CES}	Collector-Emitter Breakdown Voltage ($V_{GE} = 0V$, $I_{C} = 1.0$ mA)	1200			
V _{GE(TH)}	Gate Threshold Voltage ($V_{CE} = V_{GE}$, $I_{C} = 2.5$ mA, $T_{j} = 25^{\circ}$ C)	3.5	5.0	6.5) (- H -
V _{CE(ON)}	Collector-Emitter On Voltage (V_{GE} = 15V, I_{c} = 50A, T_{j} = 25°C)		2.5	3.2	Volts
	Collector-Emitter On Voltage (V_{GE} = 15V, I_{c} = 50A, T_{j} = 125°C)		3.3		
	Collector-Emitter On Voltage (V_{GE} = 15V, I_{c} = 100A, T_{j} = 25°C)		3.5		
I _{ces}	Collector Cut-off Current (V _{CE} = 1200V, V _{GE} = 0V, T _j = 25°C) ⁽²⁾		10	1000	μA
020	Collector Cut-off Current (V _{CE} = 1200V, V _{GE} = 0V, T _j = 125°C) ⁽²⁾		100		
I _{GES}	Gate-Emitter Leakage Current (V _{GE} = ±20V)			±250	nA

CAUTION: These Devices are Sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed.



DYNAMIC CHARACTERISTICS

Symbol	Symbol Decemptor Min Tym May					
Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
C _{ies}	Input Capacitance	Capacitance $V_{GE} = 0V, V_{CE} = 25V$ f = 1MHz		5550		
C _{oes}	Output Capacitance			500		pF
C _{res}	Reverse Transfer Capacitance			145		
V _{GEP}	Gate to Emitter Plateau Voltage	Cata Charge		7.5		V
$Q_{g}^{(3)}$	Total Gate Charge	- Gate Charge		330	445	
Q _{ge}	Gate-Emitter Charge	$V_{GE} = 15V$		52	72	
Q _{gc}	Gate- Collector Charge	- V _{CE} = 600V - I _C = 50A		156	200	nC
t _{d(on)}	Turn-On Delay Time	Inductive Switching (25°C)	1	28		
t _r	Current Rise Time	V _{cc} = 600V		38		ns
t _{d(off)}	Turn-Off Delay Time	V _{GE} = 15V		237		
t _r	Current Fall Time	I _c = 50A		45		
E _{on2} 5	Turn-On Switching Energy	$R_{g} = 4.3 \ \Omega^{(4)}$		2135	3200	μJ
E _{off}	Turn-Off Switching Energy	T _J = +25°C		1478	2210	
t _{d(on)}	Turn-On Delay Time	Inductive Switching (125°C)		28		
t,	Current Rise Time	V _{cc} = 600V		38		ns
t _{d(off)}	Turn-Off Delay Time	V _{GE} = 15V		270		
t _r	Current Fall Time	I _c = 50A		54		
E _{on2} 5	Turn-On Switching Energy	$R_{g} = 4.3 \ \Omega^{(4)}$		3157	4765	
E _{off}	Turn-Off Switching Energy	T_= +125°C		1884	2820	μJ

THERMAL AND MECHANICAL CHARACTERISTICS

Symbol	Characteristic		Min	Тур	Max	Unit
R _{ejc}	Junction to Case Thermal Resistance (IGBT)				.18	°C/W
R _{eja}	Junction to Ambient Thermal Resistance				40	0/11
	Package Weight	B2		.22		oz
W _T				6		g
		L		.36		oz
				10		g

1 Repetitive Rating: Pulse width and case temperature limited by maximum junction temperature.

2 Pulse test: Pulse Width < $380\mu s$, duty cycle < 2%.

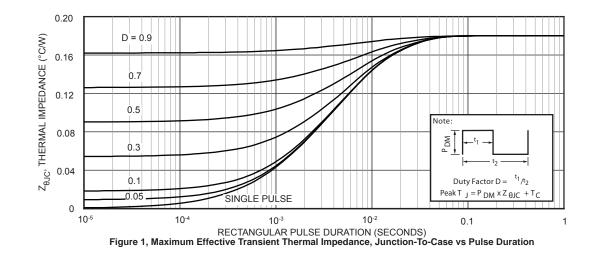
3 See Mil-Std-750 Method 3471.

4 R_g is external gate resistance, not including internal gate resistance or gate driver impedance. (MIC4452)

5 E_{on2} is the clamped inductive turn on energy that includes a commutating diode reverse recovery current in the IGBT turn on energy loss. A combi device is used for the clamping diode.

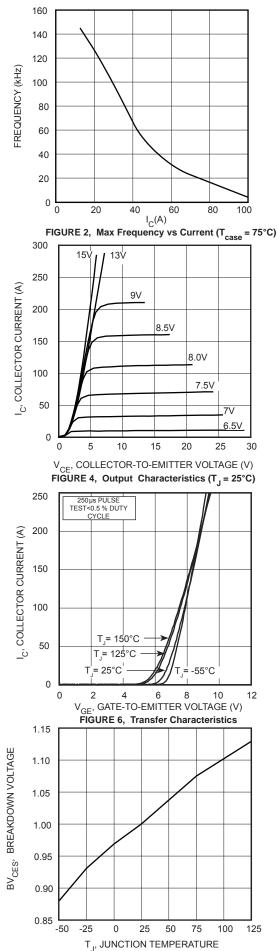
6 E_{off} is the clamped inductive turn-off energy measured in accordance with JEDEC standard JESD24-1.

Microsemi reserves the right to change, without notice, the specifications and information contained herein.

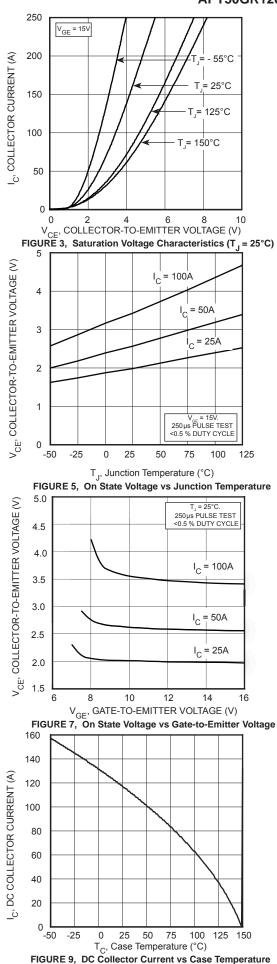


TYPICAL PERFORMANCE CURVES

APT50GR120B2_L

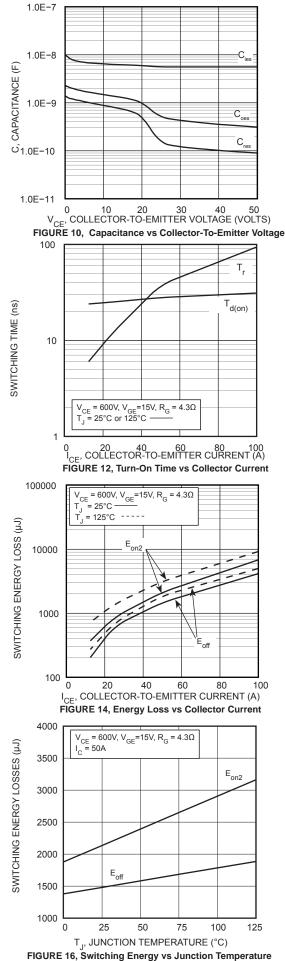


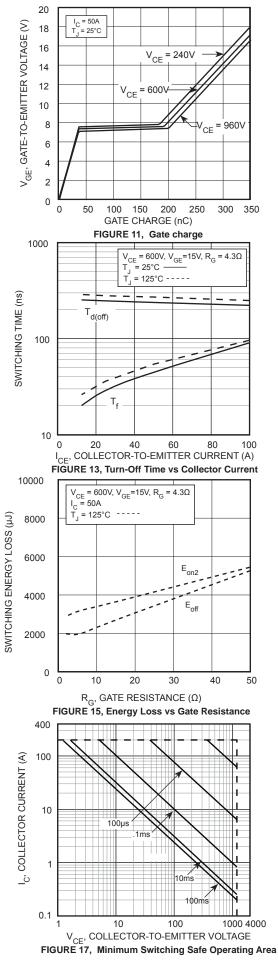




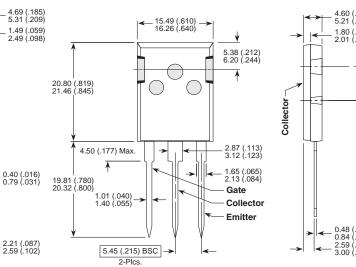








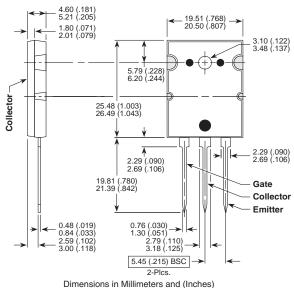
T-MAX[™] (B2) Package Outline



These dimensions are equal to the TO-247 without the mounting hole. Dimensions in Millimeters and (Inches)

Collector

→ | **|**



TO-264 (L) Package Outline

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